

Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

Series/Type: B32774 ... B32778

Date: June 2018

© EPCOS AG 2018. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.

EPCOS AG is a TDK Group Company.



Metallized polypropylene film capacitors (MKP)

B32774 ... B32778

MKP DC link – high density series up to 480 μ F

Typical applications

- Frequency converters
- Industrial and high-end power supplies
- Solar inverters

Climatic

- Max. operating temperature: 105 °C (case)
- Climatic category (IEC 60068-1:2013): 40/105/56

Construction

- Dielectric: Polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Capacitance values up to 480 μF
- High CV product, compact
- Good self-healing properties
- Over-voltage capability
- Low losses with high current capability
- High reliability
- Long useful life
- RoHS-compatible

Terminals

- Parallel wire leads, lead-free tinned
- 2-pin, 4-pin and 12-pin versions
- Standard lead lengths: 6 –1 mm

Marking

Manufacturer's logo and lot number, date code, rated capacitance (coded), capacitance tolerance (code letter) and rated DC voltage

Delivery mode

Bulk (untaped)





MKP DC link - high density series up to 480 μF

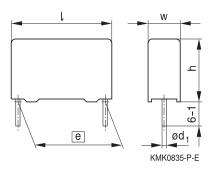
Dimensional drawings

Number of wires	Lead spacing e ±0.4	Lead diameter d ₁ ±0.05	Туре
2-pin	27.5	0.8	B32774D
2-pin	37.5	1.0	B32776E
2-pin	37.5	1.0	B32776T
4-pin	37.5	1.2	B32776G
4-pin	37.5	1.2	B32776T
4-pin	52.5	1.2	B32778T
4-pin	52.5	1.2	B32778G
12-pin	52.5	1.2	B32778J

Dimensions in mm

Dimensional drawings 2-pin versions

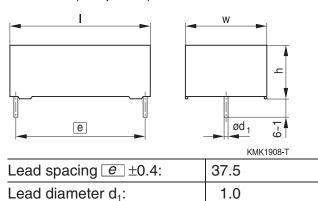
B32774D, B32776E



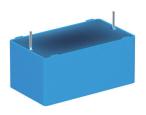
	B32774D	B32776E
Lead spacing e ±0.4:	27.5	37.5
Lead diameter d₁:	8.0	1.0

Dimensions in mm

B32776T (low profile)



Dimensions in mm



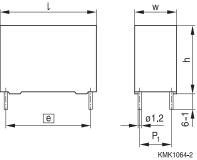




MKP DC link – high density series up to 480 μF

Dimensional drawings 4-pin versions

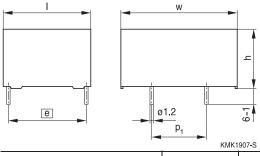
B32776G, B32778G



	B32776G	B32778G
Lead spacing e ±0.4:	37.5	52.5
Lead diameter d₁:	1.2	1.2

Dimensions in mm

B32776T, **B32778T** (low profile)

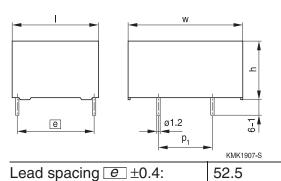


	B32776T	B32778T
Lead spacing e ±0.4:	37.5	52.5
Lead diameter d₁:	1.2	1.2

Dimensions in mm

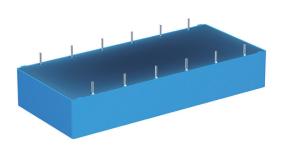
Dimensional drawing 12-pin version

B32778J



Lead diameter d₁: 1.2

Dimensions in mm







MKP DC link - high density series up to 480 μF

Overview of available types

Lead spacing 27.5 mm					37.5 mi	m				
Туре	B32774				B32776					
Page	7				8					
V _R (V DC)	450	800	1100	1300	450	575	800	900	1100	1300
C _R (μF)										
1.5										
2.0										
2.7										
3.0										
3.3										
3.5										
3.9										
5.0										
6.8										
7.0										
7.5										
8.0										
8.5										
9.0										
10										
12										
13										
14										
15										
16										
20										
22										
25										
27										
30										
35										
40										
45										
50										
60										
65										



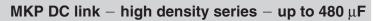


MKP DC link - high density series up to 480 μF

Overview of available types

Lead spacing	52.5 mm					
Туре	B32778					
Page	11					
V _R (V DC)	450	575	800	900	1100	1300
C _R (μF)						
14						
20						
25						
27						
30						
35						
38						
40						
42						
45						
50						
55						
58						
60						
70						
75						
80						
90						
100						
110						
120						
130						
150						
170						
180						
200						
210						
270						
360						
480						







Ordering codes and packing units (lead spacing 27.5 mm)

$C_R^{1)}$	Max. dimensions	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} ³⁾	tan δ	tan δ	Un-
	$w \times h \times l$	(composition see	70 °C	70 °C	70 °C			taped
		below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm		Α	$m\Omega$	nH	10 ⁻³	10 ⁻³	MOQ
$V_{R,70}$	$_{\rm C} = 450 \text{ V DC}, V_{\rm op,85}$	_{°C} = 450 V DC						
5.0	$11.0 \times 21.0 \times 31.5$	B32774D4505+000	5.0	21.1	19.0	1.2	10.7	2352
10.0	$15.0 \times 24.5 \times 31.5$	B32774D4106+000	8.0	10.9	24.0	1.2	11.0	1680
22.0	$22.0 \times 36.5 \times 31.5$	B32774D4226+000	14.5	5.4	30.0	1.3	12.1	784
$V_{R,70}$	_{°C} = 800 V DC, V _{op,85}	_{°C} = 700 V DC						
3.0	$11.0 \times 21.0 \times 31.5$	B32774D8305+000	4.5	24.8	19.0	0.9	7.6	2352
5.0	$14.0 \times 24.5 \times 31.5$	B32774D8505+000	6.5	15.3	23.0	0.9	7.7	1848
12.0	$22.0 \times 36.5 \times 31.5$	B32774D8126+000	13.0	6.8	34.0	1.0	8.3	784
$V_{R,70}$	$_{\rm C}$ = 1100 V DC, $V_{\rm op,85}$	_{°C} = 920 V DC						
2.0	$12.5 \times 21.5 \times 31.5$	B32774D0205+000	4.5	26.3	19.0	0.7	5.3	2100
3.3	$18.0 \times 27.5 \times 31.5$	B32774D0335+000	7.0	16.2	22.0	0.7	5.4	1428
5.0	$19.0 \times 30.0 \times 31.5$	B32774D0505+000	9.0	10.9	27.0	0.7	5.5	896
7.0	$22.0 \times 36.5 \times 31.5$	B32774D0705+000	12.0	8.1	30.0	0.7	5.8	784
$V_{R,70}$	_{°C} = 1300 V DC, V _{op,85}	_{°C} = 1100 V DC						
1.5	$12.5 \times 21.5 \times 31.5$	B32774D1155K000	4.4	31.3	20.0	0.6	4.8	2100
3.0	$18.0 \times 27.5 \times 31.5$	B32774D1305K000	7.0	16.0	24.0	0.6	4.9	1428
5.0	$22.0\times36.5\times31.5$	B32774D1505K000	10.5	9.8	33.0	0.7	5.1	784

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code: Packing code:

 $J = \pm 5\%$

 $K = \pm 10\%$

000 = untaped (lead length 6 - 1 mm)

¹⁾ Capacitance value measured at 1 kHz

²⁾ Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \le$ 20 °C at $\Delta ESR_{typ} \le \pm 5\%$

³⁾ Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)





MKP DC link - high density series - up to 480 μF

Ordering codes and packing units (lead spacing 37.5 mm)

$C_R^{1)}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} 3)	$tan \ \delta$	tan δ	Un-
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C			taped
			below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm	mm		Α	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
$\overline{V_{R,70}}$	°C = 450 V DC, V _{op}	₈₅ ° _C =	450 V DC						
12	24.0 × 15.0 × 41.5	_	B32776T4126K000	7.0	17.1	19.0	2.2	21.0	1040
16	$24.0 \times 19.0 \times 41.5$	_	B32776T4166K000	8.0	13.0	18.0	2.3	21.2	780
30	$20.0 \times 39.5 \times 41.5$	10.2	B32776G4306+000	14.0	7.0	11.0	2.3	21.3	640
30	$20.0 \times 39.5 \times 41.5$	_	B32776E4306+000	14.0	7.3	28.0	2.4	22.3	640
35	$28.0 \times 37.0 \times 42.0$	10.2	B32776G4356+000	16.5	6.0	10.0	2.3	21.4	440
35	$28.0 \times 37.0 \times 42.0$	_	B32776E4356+000	16.0	6.4	24.0	2.4	22.6	440
40	$28.0 \times 37.0 \times 42.0$	10.2	B32776G4406+000	17.5	5.3	11.0	2.3	21.4	440
40	$28.0 \times 37.0 \times 42.0$	_	B32776E4406+000	17.0	5.6	26.0	2.4	22.7	440
40	$43.0 \times 22.0 \times 41.5$	20.3	B32776T4406K000	17.0	5.2	13.0	2.3	21.2	280
50	$28.0 \times 42.5 \times 41.5$	10.2	B32776G4506+000	20.0	4.3	12.0	2.3	21.7	440
50	$28.0 \times 42.5 \times 41.5$	_	B32776E4506+000	19.0	4.7	30.0	2.5	23.8	440
60	$30.0 \times 45.0 \times 42.0$	20.3	B32776G4606+000	23.5	3.6	14.0	2.4	22.3	400
60	$30.0 \times 45.0 \times 42.0$	_	B32776E4606+000	22.0	4.0	32.0	2.5	24.2	400
65	$33.0\times48.0\times42.0$	20.3	B32776G4656+000	25.5	3.3	14.0	2.3	22.2	180
$V_{R,70}$	$_{\text{C}}$ = 575 V DC, V_{op}	₈₅ ° _C =	500 V DC						
8.5	$24.0 \times 15.0 \times 41.5$	_	B32776T5855+000	6.5	19.9	19.0	1.9	17.2	1040
12	$24.0 \times 19.0 \times 41.5$	_	B32776T5126K000	8.0	14.4	18.0	1.9	17.4	780
25	$20.0 \times 39.5 \times 41.5$	10.2	B32776G5256K000	14.0	7.0	12.0	1.9	17.5	640
25	$20.0 \times 39.5 \times 41.5$	_	B32776E5256K000	13.5	7.4	28.0	2.0	18.3	640
27	$43.0 \times 22.0 \times 41.5$	20.3	B32776T5276K000	15.5	6.4	14.0	1.9	17.5	280
30	$28.0 \times 37.0 \times 42.0$	10.2	B32776G5306K000	16.5	5.8	11.0	1.9	17.6	440
30	$28.0 \times 37.0 \times 42.0$	_	B32776E5306K000	16.5	6.1	26.0	2.0	18.5	440
35	$28.0 \times 42.5 \times 41.5$	10.2	B32776G5356+000	19.0	5.0	12.0	1.9	17.8	440
35	$28.0 \times 42.5 \times 41.5$	_	B32776E5356+000	18.0	5.3	29.0	2.0	19.0	440
45	$30.0 \times 45.0 \times 42.0$	20.3	B32776G5456K000	22.0	4.0	13.0	1.9	17.9	400
45	$30.0 \times 45.0 \times 42.0$	_	B32776E5456K000	21.0	4.4	32.0	2.1	19.7	400
50	$33.0\times48.0\times42.0$	20.3	B32776G5506K000	25.0	3.5	14.0	2.0	18.1	180

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

Packing code:

 $J = \pm 5\%$

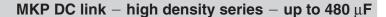
000 = untaped (lead length 6 - 1 mm)

 $K = \pm 10\%$

- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \leq \!\! 20$ °C at $\Delta ESR_{typ} \leq \! \pm \! 5\%$
- 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)

¹⁾ Capacitance value measured at 1 kHz







Ordering codes and packing units (lead spacing 37.5 mm)

$\overline{C_R^{1)}}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} 3)	$tan \ \delta$	tan δ	Un-
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C			taped
			below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm	mm		Α	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
$V_{R,70}$	°C = 800 V DC, V _{op}	₈₅ ° _C =	700 V DC						
6.8	24.0 × 15.0 × 41.5	_	B32776T8685+000	6.0	22.1	18.0	1.7	15.1	1040
8.5	24.0 × 19.0 × 41.5	_	B32776T8855+000	7.5	17.8	18.0	1.7	15.1	780
14	$18.0 \times 32.5 \times 41.5$	_	B32776E8146+000	10.0	11.5	23.0	1.8	16.3	720
15	$20.0 \times 39.5 \times 41.5$	10.2	B32776G8156+000	12.0	9.6	10.0	1.7	15.2	640
15	$20.0 \times 39.5 \times 41.5$	_	B32776E8156+000	11.5	10.3	24.0	1.7	15.7	640
20	$28.0 \times 37.0 \times 42.0$	10.2	B32776G8206+000	14.5	7.5	10.0	1.7	15.3	440
20	$28.0 \times 37.0 \times 42.0$	_	B32776E8206+000	14.5	7.8	24.0	1.7	15.9	440
20	$43.0 \times 22.0 \times 41.5$	20.3	B32776T8206K000	14.5	7.2	14.0	1.7	15.1	280
22	$28.0 \times 37.0 \times 42.0$	10.2	B32776G8226+000	15.5	6.8	11.0	1.7	15.3	440
22	$28.0 \times 37.0 \times 42.0$	_	B32776E8226+000	15.0	7.1	25.0	1.7	16.0	440
25	$28.0 \times 42.5 \times 41.5$	10.2	B32776G8256+000	17.0	6.1	11.0	1.7	15.4	440
25	$28.0 \times 42.5 \times 41.5$	_	B32776E8256+000	16.5	6.4	28.0	1.8	16.3	440
30	$30.0 \times 45.0 \times 42.0$	20.3	B32776G8306+000	19.5	5.1	12.0	1.7	15.6	400
30	$30.0 \times 45.0 \times 42.0$	_	B32776E8306+000	19.0	5.5	30.0	1.8	16.7	400
35	$33.0 \times 48.0 \times 42.0$	20.3	B32776G8356+000	22.0	4.3	14.0	1.7	15.7	180
$V_{R,70}$	$_{\text{C}}$ = 900 V DC, V_{op}	₈₅ ° _C =	800 V DC						
5	$24.0 \times 15.0 \times 41.5$	_	B32776T9505+000	5.5	26.1	19.0	1.5	13.4	1040
7.5	$24.0 \times 19.0 \times 41.5$	_	B32776T9755K000	7.5	17.8	18.0	1.5	13.5	780
15	$20.0 \times 39.5 \times 41.5$	10.2	B32776G9156K000	12.5	9.1	12.0	1.5	13.6	640
15	$20.0 \times 39.5 \times 41.5$	_	B32776E9156K000	12.0	9.4	28.0	1.5	14.1	640
16	$43.0 \times 22.0 \times 41.5$	20.3	B32776T9166K000	14.0	8.1	14.0	1.5	13.5	280
20	$28.0 \times 37.0 \times 42.0$	10.2	B32776G9206K000	15.0	7.0	11.0	1.5	13.6	440
20	$28.0 \times 37.0 \times 42.0$	_	B32776E9206K000	15.0	7.3	26.0	1.6	14.2	440
22	$28.0 \times 42.5 \times 41.5$	10.2	B32776G9226K000	17.0	6.3	12.0	1.5	13.7	440
22	$28.0 \times 42.5 \times 41.5$	_	B32776E9226K000	16.5	6.6	29.0	1.6	14.5	440
25	$30.0 \times 45.0 \times 42.0$	20.3	B32776G9256+000	19.0	5.5	13.0	1.5	13.8	400
25	$30.0 \times 45.0 \times 42.0$	_	B32776E9256+000	18.5	5.9	32.0	1.6	14.7	400
30	$33.0\times48.0\times42.0$	20.3	B32776G9306+000	21.5	4.7	14.0	1.5	13.9	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

Packing code:

 $J = \pm 5\%$ $K = \pm 10\%$ 000 = untaped (lead length 6 - 1 mm)

- 1) Capacitance value measured at 1 kHz
- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \le$ 20 °C at $\Delta ESR_{typ} \le \pm 5\%$
- 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)





MKP DC link - high density series - up to 480 μF

Ordering codes and packing units (lead spacing 37.5 mm)

$\overline{C_R^{1)}}$	Max. dimensions	P ₁	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} ³⁾	tan δ	tan δ	Un-
	$w \times h \times I$		(composition see	70 °C	70 °C	70 °C			taped
			below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm	mm	,	Α	mΩ	nH	10 ⁻³	10 ⁻³	MOQ
$V_{R,70}$	_C = 1100 V DC, V _{op}	₈₅ ° _C =	920 V DC						
3.9	$24.0 \times 15.0 \times 41.5$	_	B32776T0395+000	5.0	30.5	18.0	1.4	12.1	1040
5	$24.0 \times 19.0 \times 41.5$	_	B32776T0505+000	6.5	23.6	18.0	1.4	12.1	780
12	$20.0 \times 39.5 \times 41.5$	10.2	B32776G0126+000	12.0	10.2	12.0	1.4	12.2	640
12	$20.0 \times 39.5 \times 41.5$	_	B32776E0126+000	11.5	10.5	28.0	1.4	12.6	640
13	$43.0 \times 22.0 \times 41.5$	20.3	B32776T0136K000	13.0	8.9	14.0	1.4	12.1	280
14	$28.0 \times 37.0 \times 42.0$	10.2	B32776G0146+000	13.5	8.7	21.0	1.4	12.2	440
14	$28.0 \times 37.0 \times 42.0$	_	B32776E0146+000	13.5	9.0	25.0	1.4	12.6	440
16	$28.0 \times 42.5 \times 41.5$	10.2	B32776G0166+000	15.5	7.4	12.0	1.4	12.3	440
16	$28.0 \times 42.5 \times 41.5$	_	B32776E0166+000	15.0	7.8	30.0	1.4	12.9	440
20	$30.0 \times 45.0 \times 42.0$	20.3	B32776G0206+000	18.0	6.0	14.0	1.4	12.4	400
20	$30.0 \times 45.0 \times 42.0$	_	B32776E0206+000	17.5	6.5	32.0	1.4	13.1	400
22	$33.0\times48.0\times42.0$	20.3	B32776G0226+000	21.0	4.9	15.0	1.3	11.4	180
$V_{R,70}$	°C = 1300 V DC, V _{op}	₈₅ ° _C =	1100 V DC						
2.7	$24.0 \times 15.0 \times 41.5$	_	B32776T1275+000	5.0	34.7	19.0	1.1	9.6	1040
3.5	$24.0 \times 19.0 \times 41.5$	_	B32776T1355+000	6.0	27.4	18.0	1.1	9.7	780
8.0	$20.0 \times 39.5 \times 41.5$	10.2	B32776G1805+000	11.0	12.1	12.0	1.1	9.7	640
8.0	$20.0 \times 39.5 \times 41.5$	_	B32776E1805+000	10.5	12.4	24.0	1.2	10.0	640
9.0	$43.0 \times 22.0 \times 41.5$	20.3	B32776T1905K000	12.0	10.7	13.0	1.1	9.7	280
10	$28.0 \times 37.0 \times 42.0$	10.2	B32776G1106+000	13.0	9.6	11.0	1.1	9.7	440
10	$28.0 \times 37.0 \times 42.0$	_	B32776E1106+000	12.5	9.9	26.0	1.2	10.0	440
12	$28.0 \times 42.5 \times 41.5$	10.2	B32776G1126+000	14.5	8.1	12.0	1.1	9.8	440
12	$28.0 \times 42.5 \times 41.5$	_	B32776E1126+000	14.0	8.5	28.0	1.2	10.1	440
14	$30.0 \times 45.0 \times 42.0$	20.3	B32776G1146+000	17.0	6.8	14.0	1.1	10.1	400
14	$30.0 \times 45.0 \times 42.0$	_	B32776E1146+000	16.5	7.3	32.0	1.2	10.4	400
16	$33.0\times48.0\times42.0$	20.3	B32776G1166+000	19.0	6.0	15.0	1.1	9.9	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$

K = ±10%

Packing code:

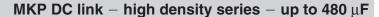
000 = untaped (lead length 6 - 1 mm)

¹⁾ Capacitance value measured at 1 kHz

²⁾ Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \leq \!\! 20$ °C at $\Delta ESR_{typ} \leq \! \pm 5\%$

³⁾ Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)







Ordering codes and packing units (lead spacing 52.5 mm, $P_1 = 20.3$ mm)

$C_R^{1)}$	Max. dimensions	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} ³⁾	tan δ	tan δ	Un-
	$w \times h \times I$	(composition see	70 °C	70 °C	70 °C			taped
		below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm		Α	mΩ	nH	10 ⁻³	10-3	MOQ
V _{R,70}	$_{\rm C} = 450 \text{ V DC}, V_{\rm op,85}$	_{°C} = 450 V DC						
55	$43.0 \times 24.0 \times 57.5$	B32778T4556K000	16.5	7.2	13.0	4.3	41.7	560
75	$30.0 \times 45.0 \times 57.5$	B32778G4756+000	21.0	5.6	12.0	4.4	42.6	280
80	$30.0 \times 45.0 \times 57.5$	B32778G4806+000	21.5	5.3	13.0	4.4	42.7	280
100	$35.0 \times 50.0 \times 57.5$	B32778G4107+000	26.0	4.3	14.0	4.5	43.3	108
110	$35.0 \times 50.0 \times 57.5$	B32778G4117K000	27.0	3.9	15.0	4.5	43.6	108
150	$130.0 \times 24.0 \times 57.5$	B32778J4157K000	43.5	2.7	4.0	4.4	42.1	80
170	$45.0 \times 57.0 \times 57.5$	B32778G4177+000	36.5	2.6	17.0	4.6	45.7	140
180	$60.0 \times 45.0 \times 57.5$	B32778G4187+000	39.0	2.5	19.0	4.6	44.6	200
480	$130.0 \times 58.0 \times 57.5$	B32778J4487K000	79.5	0.9	6.0	4.8	45.4	40
V _{R,70}	_C = 575 V DC, V _{op,85}	_{°C} = 500 V DC						
40	$43.0 \times 24.0 \times 57.5$	B32778T5406K000	15.5	8.5	13.0	3.6	34.5	560
60	$30.0 \times 45.0 \times 57.5$	B32778G5606+000	20.5	5.8	13.0	3.7	35.3	280
80	$35.0 \times 50.0 \times 57.5$	B32778G5806+000	25.5	4.4	15.0	3.7	36.0	108
110	$130.0 \times 24.0 \times 57.5$	B32778J5117K000	40.5	3.0	5.0	3.6	34.5	80
120	$45.0 \times 57.0 \times 57.5$	B32778G5127+000	34.5	3.1	17.0	3.8	37.2	140
130	$60.0 \times 45.0 \times 57.5$	B32778G5137+000	36.5	2.8	19.0	3.8	36.7	200
360	$130.0 \times 58.0 \times 57.5$	B32778J5367K000	75.0	1.0	6.0	4.0	37.3	40
V _{R,70}	_{°C} = 800 V DC, V _{op,85}	_{°C} = 700 V DC						
30	$43.0 \times 24.0 \times 57.5$	B32778T8306K000	14.5	9.8	14.0	3.2	30.2	560
45	$30.0 \times 45.0 \times 57.5$	B32778G8456+000	19.5	6.6	14.0	3.2	30.9	280
50	$30.0 \times 45.0 \times 57.5$	B32778G8506+000	20.0	6.3	13.0	3.2	30.9	280
55	$35.0 \times 50.0 \times 57.5$	B32778G8556+000	23.0	5.6	14.0	3.2	31.1	108
60	$35.0 \times 50.0 \times 57.5$	B32778G8606+000	23.5	5.1	15.0	3.3	31.2	108
80	$130.0 \times 24.0 \times 57.5$	B32778J8806K000	37.5	3.6	4.0	3.2	30.2	80
90	$45.0 \times 57.0 \times 57.5$	B32778G8906+000	32.5	3.5	17.0	3.3	32.2	140
100	$60.0 \times 45.0 \times 57.5$	B32778G8107+000	34.5	3.2	19.0	3.3	31.9	200
270	$130.0 \times 58.0 \times 57.5$	B32778J8277K000	70.5	1.2	6.0	3.5	32.4	40

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

Packing code:

 $J = \pm 5\%$

000 = untaped (lead length 6 - 1 mm)

 $K = \pm 10\%$

- 2) Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \le \!\! 20$ °C at $\Delta ESR_{typ} \le \! \pm \!\! 5\%$
- 3) Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)

¹⁾ Capacitance value measured at 1 kHz





MKP DC link - high density series - up to 480 μF

Ordering codes and packing units (lead spacing 52.5 mm, $P_1 = 20.3$ mm)

$C_R^{1)}$	Max. dimensions	Ordering code	I _{RMS,max} ²⁾	ESR _{typ}	ESL _{typ} ³⁾	tan δ	tan δ	Un-
	$w \times h \times l$	(composition see	70 °C	70 °C	70 °C			taped
		below)	10 kHz	10 kHz	10 kHz	1 kHz	10 kHz	pcs./
μF	mm	,	Α	$m\Omega$	nH	10 ⁻³	10 ⁻³	MOQ
V _{R,70}	_{CC} = 900 V DC, V _{op,85}	°c = 800 V DC						
25	$43.0 \times 24.0 \times 57.5$	B32778T9256K000	13.5	10.7	13.0	2.8	26.8	560
35	$30.0 \times 45.0 \times 57.5$	B32778G9356+000	18.0	7.7	13.0	2.9	27.3	280
50	$35.0 \times 50.0 \times 57.5$	B32778G9506K000	22.5	5.6	15.0	2.9	27.7	108
70	$45.0 \times 57.0 \times 57.5$	B32778G9706+000	31.0	3.8	18.0	3.0	28.5	140
70	$130.0 \times 24.0 \times 57.5$	B32778J9706K000	36.0	3.8	4.0	2.9	27.2	80
75	$60.0 \times 45.0 \times 57.5$	B32778G9756+000	32.5	3.6	20.0	2.9	28.2	200
210	$130.0 \times 58.0 \times 57.5$	B32778J9217K000	66.0	1.3	6.0	3.1	28.6	40
V _{R,70}	$_{\rm C}$ = 1100 V DC, $V_{\rm op,85}$	°c = 920 V DC						
20	$43.0 \times 24.0 \times 57.5$	B32778T0206K000	13.0	11.9	13.0	2.6	24.1	560
30	$30.0 \times 45.0 \times 57.5$	B32778G0306+000	17.5	8.2	13.0	2.6	24.5	280
40	$35.0 \times 50.0 \times 57.5$	B32778G0406+000	21.5	6.2	15.0	2.7	25.9	108
58	$45.0 \times 57.0 \times 57.5$	B32778G0586+000	29.0	4.3	17.0	2.7	25.4	140
60	$60.0 \times 45.0 \times 57.5$	B32778G0606+000	30.5	4.0	19.0	2.7	25.2	200
60	$130.0 \times 24.0 \times 57.5$	B32778J0606K000	34.5	4.1	4.0	2.7	25.1	80
200	$130.0 \times 58.0 \times 57.5$	B32778J0207K000	66.0	1.4	6.0	3.0	26.8	40
V _{R,70}	$_{\rm C}$ = 1300 V DC, $V_{\rm op,85}$	_{5°C} = 1100 V DC						
14	$43.0 \times 24.0 \times 57.5$	B32778T1146K000	12.0	13.8	13.0	2.1	19.5	560
20	$30.0 \times 45.0 \times 57.5$	B32778G1206+000	16.0	9.7	13.0	2.1	19.8	280
25	$35.0 \times 50.0 \times 57.5$	B32778G1256+000	19.0	7.8	15.0	2.1	19.9	108
27	$35.0 \times 50.0 \times 57.5$	B32778G1276+000	19.5	7.3	15.0	2.1	20.0	108
38	$130.0 \times 24.0 \times 57.5$	B32778J1386K000	31.5	5.1	4.0	2.1	19.5	80
40	$45.0 \times 57.0 \times 57.5$	B32778G1406+000	26.5	5.0	17.0	2.2	20.3	140
42	$60.0 \times 45.0 \times 57.5$	B32778G1426+000	28.0	4.7	19.0	2.2	20.2	200
120	$130.0 \times 58.0 \times 57.5$	B32778J1127K000	58.5	1.7	6.0	2.3	20.5	40
	·							_

MOQ = Minimum Order Quantity, consisting of 4 packing units. Intermediate capacitance values are available on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $J = \pm 5\%$

 $K = \pm 10\%$

Packing code:

000 = untaped (lead length 6 - 1 mm)

¹⁾ Capacitance value measured at 1 kHz

²⁾ Max ripple current I_{RMS} at 70 °C, 10 kHz for $\Delta T \le \! 20$ °C at $\Delta ESR_{typ} \le \! \pm \! 5\%$

³⁾ Typical ESL value measured at resonance frequency (see specific graphs of Z versus frequency)





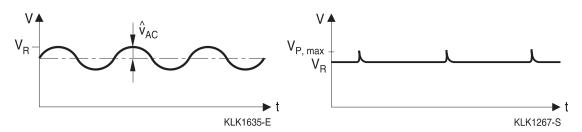


Technical data

Reference standard: IEC 61071:2007. All data given at T = 20 °C, unless otherwise specified.

Reference standard. IEC 61071.2007. At	i uala give	z_{11} at $1=2$	20 C, uili	ess officin	wise spec	illeu.		
Operating temperature range (case)	Max. ope	05 °C						
	Upper category temperature T _{max} +105							
	Lower ca	ategory te	mperature	$\in T_{min}$	-4	40 °C		
Insulation resistance R _{ins}	τ > 10 000 s (after 1 min.)							
given as time constant	For V _B ≥ 500 V measured at 500 V							
$\tau = C_R \cdot R_{ins}$, rel. humidity $\leq 65\%$	For V _B < 500 V measured at V _B							
(minimum as-delivered values)								
DC test voltage between terminals (10 s)	1.5 · V _R							
Voltage test terminal to case (10 s)	2110 V AC, 50 Hz							
Pulse Handling Capability (V/µs)	I _P (A) / C (μF)							
Reliability: Failure rate λ	10 fit (≤ 1 · 10 ⁻⁹ /h) at 0.5 · V _R , 40 °C							
	For conversion to other operating conditions and							
	temperatures, refer to chapter "Quality, 2 Reliability".							
Service life t_{SL}	100 000 h at V _R and 70 °C							
V _R (V DC)	450	575	800	900	1100	1300		
Continuous operation voltage								
V _{op} (V DC) at 70 °C	450	575	800	900	1100	1300		
Continuous operation voltage								
V _{op} (V DC) at 85 °C	450	500	700	800	920	1100		
For temperatures between 85 °C and 105 °C	1.33%/°C of V _{op} derating compared to V _{op} at 85 °C							

Typical waveforms



Restrictions:

 \mathbf{V}_{R} : Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.





MKP DC link – high density series up to 480 μ F

 $\hat{v}_{AC} \leq 0.2 \cdot V_{R}$

Overvoltage	Maximum duration within one day	Observation		
1.1 · V _R	30% of on-load duration	System regulation		
1.15 · V _R	30 min.	System regulation		
$1.2 \cdot V_R$	5 min.	System regulation		
1.3 · V _R	1 min.	System regulation		

NOTE 1 An overvoltage equal to $1.5 \cdot V_R$ for 30 ms is permitted 1000 times during the life of the capacitor.

The amplitudes of the overvoltages that may be tolerated without significant reduction in the life time of the capacitor depend on their duration, the number of application and the capacitor temperature.

In addition these values assume that the overvoltages may appear when the internal temperature of the capacitor is less than 0 °C but within the temperature category.

NOTE 2 The average applied voltage must not be higher than the specified voltage.

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

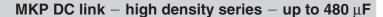
Note:

The values of dV/dt provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt values

Lead spacing	27.5	mm			37.5 mm					52.5 mm						
Туре	B32	774			B32776			B32778								
V _R (V DC)	450	800	1100	1300	450	575	800	900	1100	1300	450	575	800	900	1100	1300
dV/dt in V/μs	30	40	75	100	21	22	22	35	54	73	14	14	15	22	35	50







Characteristics curves

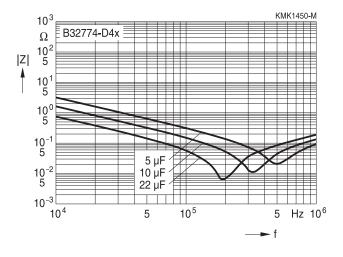
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

450 V DC

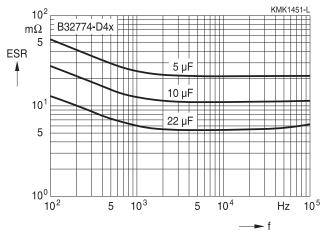


ESR versus frequency f

(typical values)

Lead spacing 27.5 mm

450 V DC

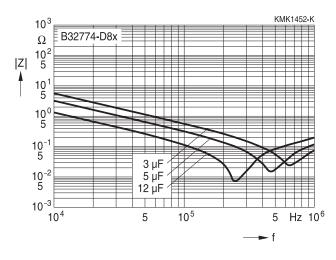


Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

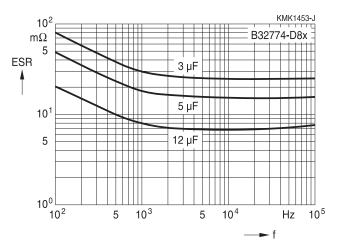
800 V DC



ESR versus frequency f

(typical values)

Lead spacing 27.5 mm







MKP DC link – high density series – up to 480 μ F

Characteristics curves

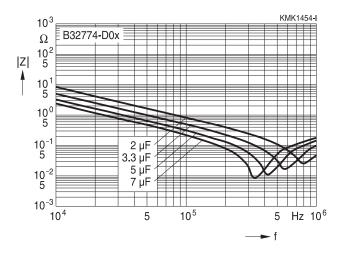
Additional technical information can be found under "Design support" on www.epcos.com.

Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

1100 V DC

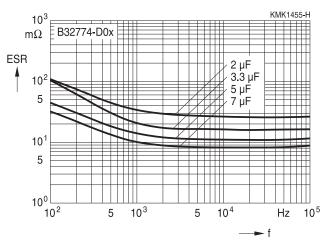


ESR versus frequency f

(typical values)

Lead spacing 27.5 mm

1100 V DC

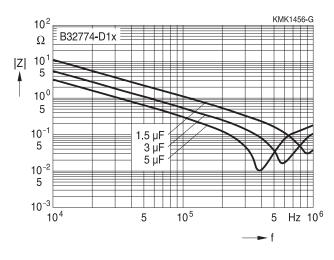


Impedance Z versus frequency f

(typical values)

Lead spacing 27.5 mm

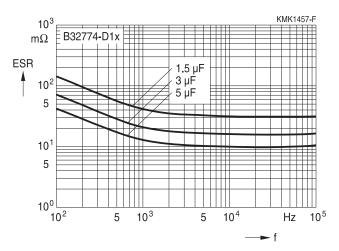
1300 V DC



ESR versus frequency f

(typical values)

Lead spacing 27.5 mm





MKP DC link - high density series - up to 480 μF



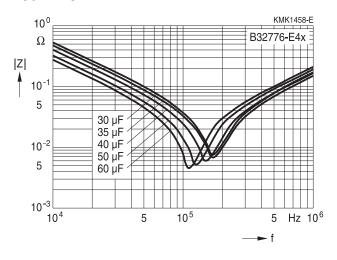
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

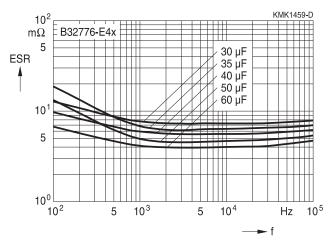
450 V DC



ESR versus frequency f (typical values)

Lead spacing 37.5 mm

450 V DC

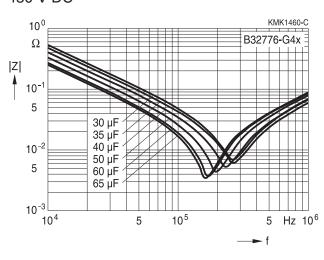


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

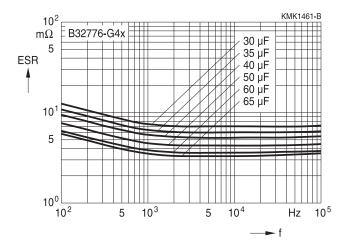
450 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm







MKP DC link - high density series - up to 480 μF

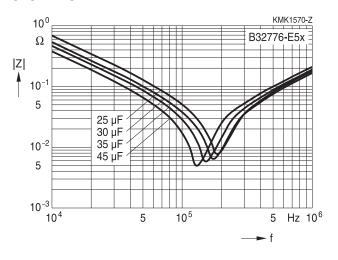
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

575 V DC

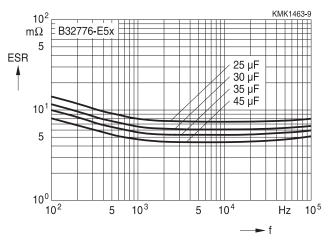


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

575 V DC

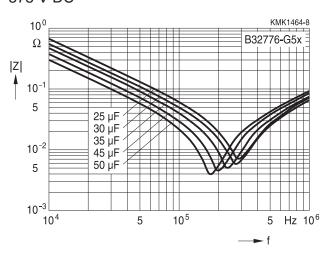


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

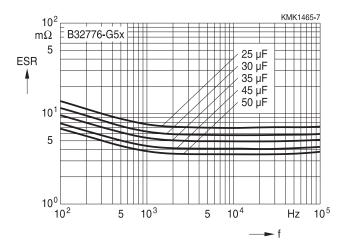
575 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm





MKP DC link – high density series – up to 480 μ F



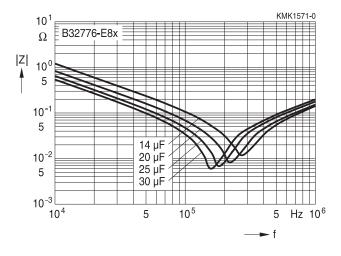
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

B32776E8*/800 V DC

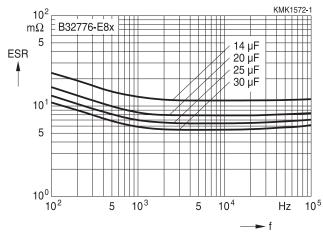


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

B32776E8*/800 V DC

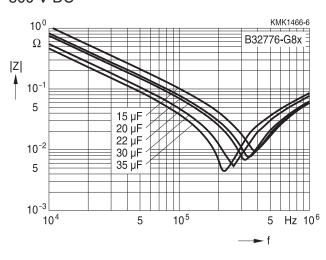


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

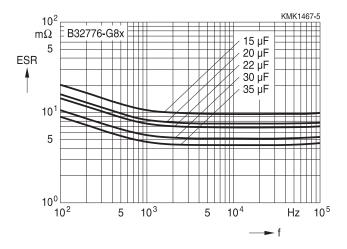
800 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm







MKP DC link - high density series - up to 480 μF

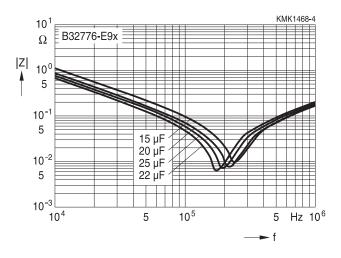
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

900 V DC

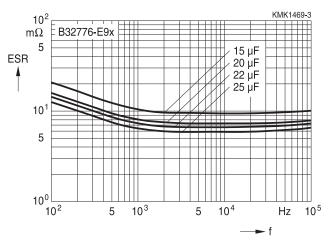


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

900 V DC

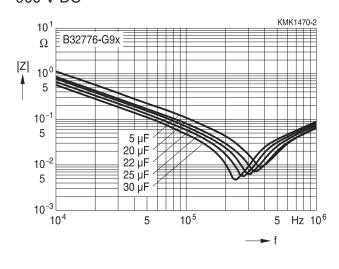


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

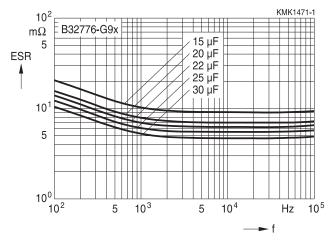
900 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm





MKP DC link - high density series - up to 480 μF



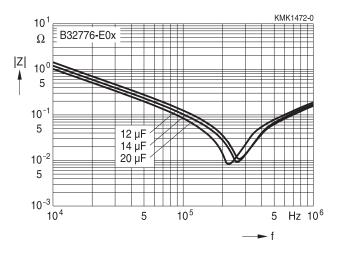
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

1100 V DC

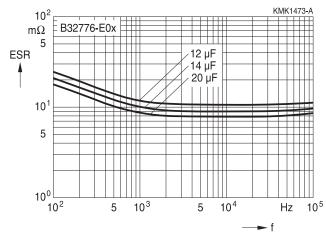


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

1100 V DC

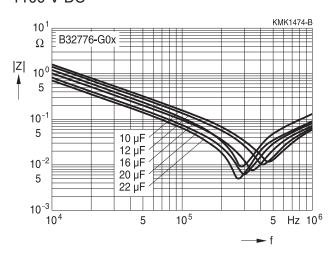


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

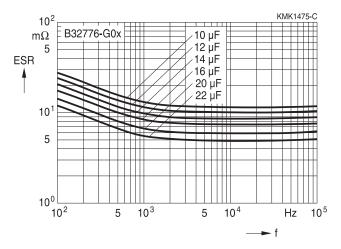
1100 V DC



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm







MKP DC link - high density series - up to 480 μF

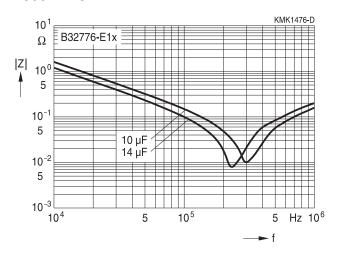
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

1300 V DC

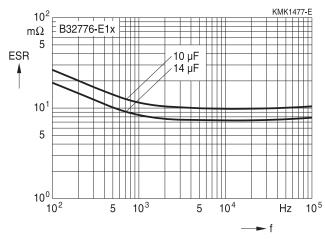


ESR versus frequency f

(typical values)

Lead spacing 37.5 mm

1300 V DC

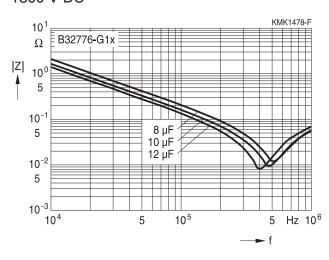


Impedance Z versus frequency f

(typical values)

Lead spacing 37.5 mm

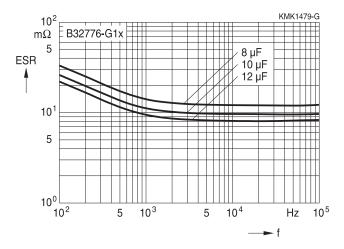
1300 V DC



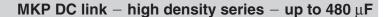
ESR versus frequency f

(typical values)

Lead spacing 37.5 mm





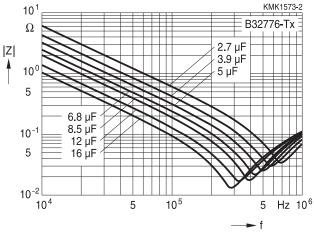




Characteristics curves

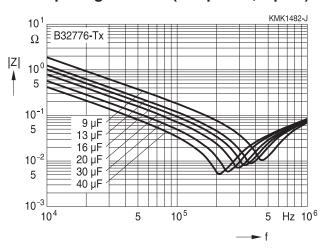
Impedance Z versus frequency f (typical values)

Lead spacing 37.5 mm (low profile, 2 pins)



Impedance Z versus frequency f (typical values)

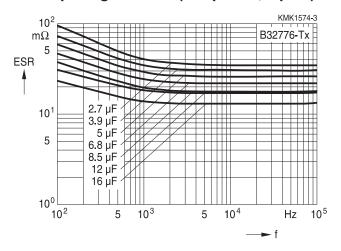
Lead spacing 37.5 mm (low profile, 4 pins)



ESR versus frequency f

(typical values)

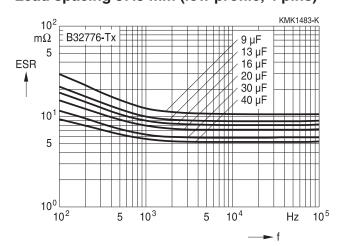
Lead spacing 37.5 mm (low profile, 2 pins)



ESR versus frequency f

(typical values)

Lead spacing 37.5 mm (low profile, 4 pins)







MKP DC link - high density series - up to 480 μF

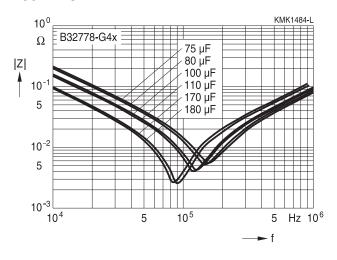
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

450 V DC

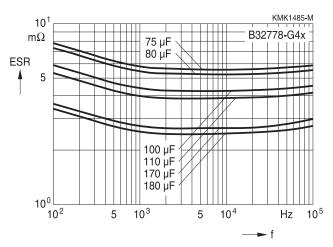


ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

450 V DC

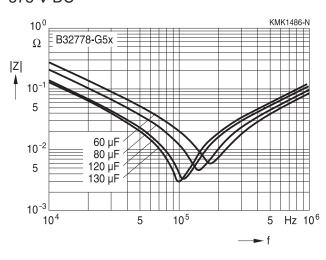


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

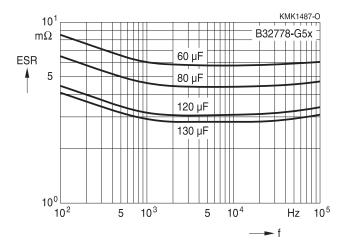
575 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm





MKP DC link - high density series - up to 480 μF



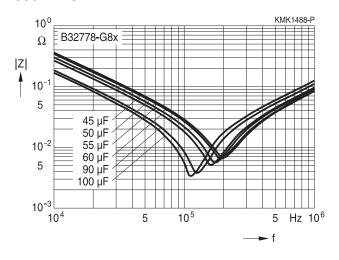
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

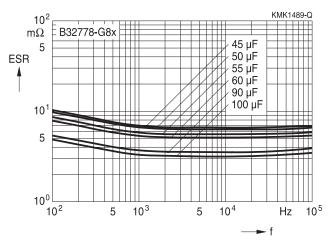
800 V DC



ESR versus frequency f (typical values)

Lead spacing 52.5 mm

800 V DC

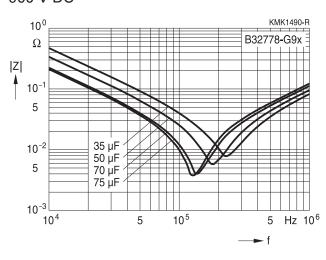


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

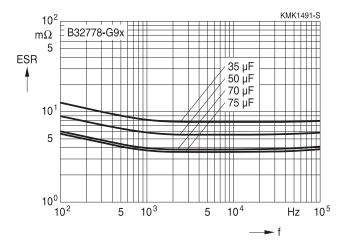
900 V DC



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm







MKP DC link – high density series – up to 480 μ F

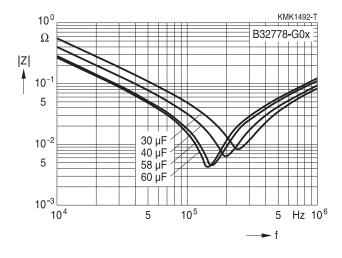
Characteristics curves

Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

B32778G0*/1100 V DC

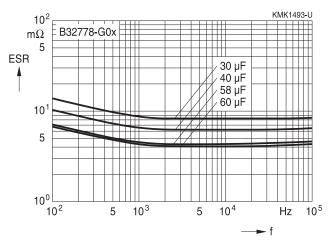


ESR versus frequency f

(typical values)

Lead spacing 52.5 mm

B32778G0*/1100 V DC

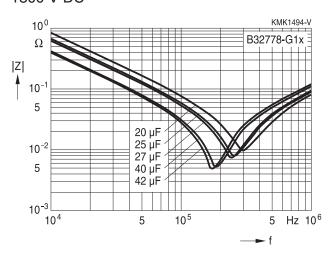


Impedance Z versus frequency f

(typical values)

Lead spacing 52.5 mm

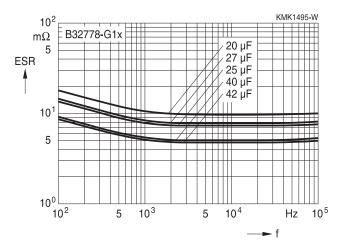
1300 V DC



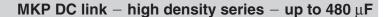
ESR versus frequency f

(typical values)

Lead spacing 52.5 mm





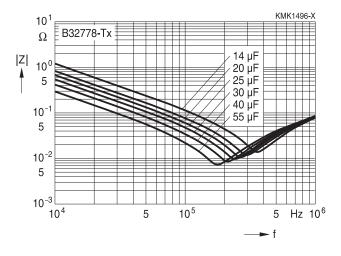




Characteristics curves

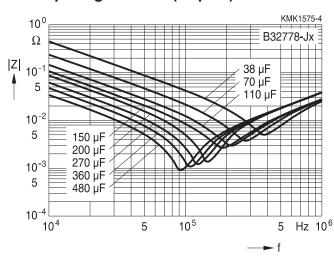
Impedance Z versus frequency f (typical values)

Lead spacing 52.5 mm (low profile)



Impedance Z versus frequency f (typical values)

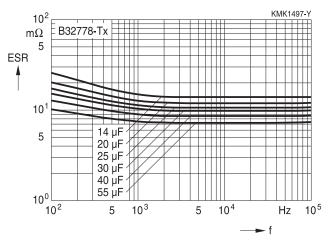
Lead spacing 52.5 mm (12 pins)



ESR versus frequency f

(typical values)

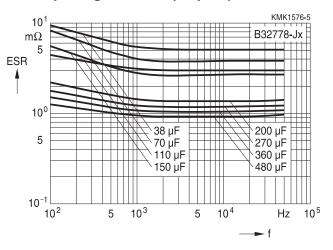
Lead spacing 52.5 mm (low profile)



ESR versus frequency f

(typical values)

Lead spacing 52.5 mm (12 pins)







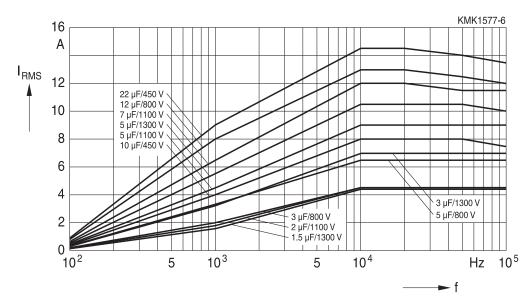
MKP DC link - high density series - up to 480 μF

Characteristics curves

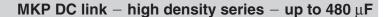
Permissible current I_{RMS} versus frequency f at 70 $^{\circ}$ C

Lead spacing 27.5 mm

B32774D*







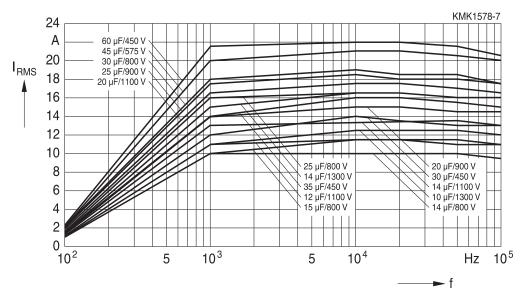


Characteristics curves

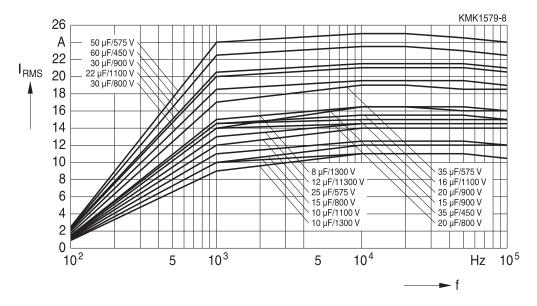
Permissible current I_{RMS} versus frequency f at 70 °C

Lead spacing 37.5 mm

B32776E*



B32776G*







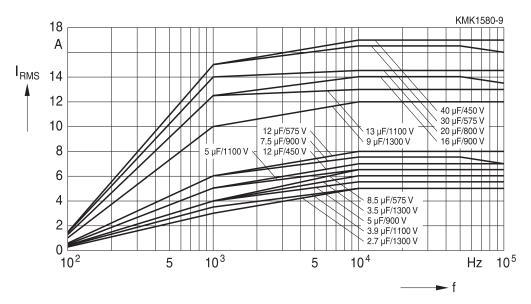
MKP DC link - high density series - up to 480 μF

Characteristics curves

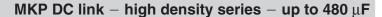
Permissible current I_{RMS} versus frequency f at 70 $^{\circ}$ C

Lead spacing 37.5 mm

B32776T*







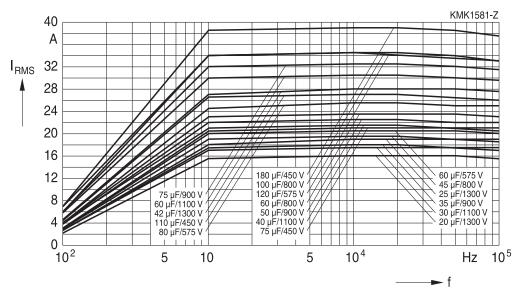


Characteristics curves

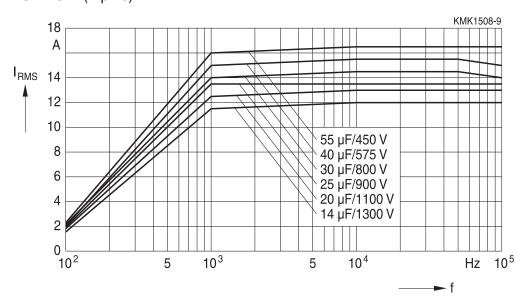
Permissible current I_{RMS} versus frequency f at 70 $^{\circ}$ C

Lead spacing 52.5 mm

B32778G* (4 pins)



B32778T* (4 pins)







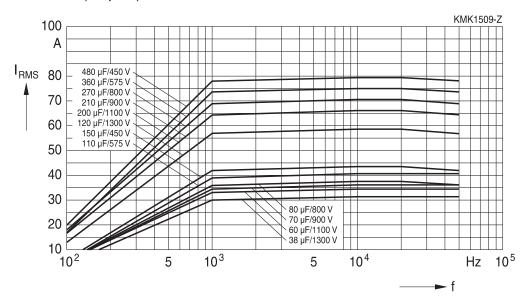
MKP DC link - high density series - up to 480 μF

Characteristics curves

Permissible current I_{RMS} versus frequency f at 70 $^{\circ}$ C

Lead spacing 52.5 mm

B32778J* (12 pins)

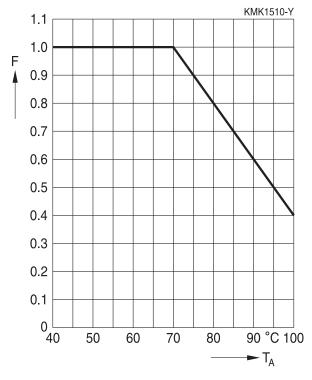






MKP DC link - high density series up to 480 μF

Curves characteristics (I_{RMS} derating versus temperature)



Maximum I_{RMS} current as function of the ambient temperature: I_{RMS} (T_A) = Factor \times I_{RMS} (70 °C)





MKP DC link – high density series up to 480 μ F

Heat transference for self heating calculation

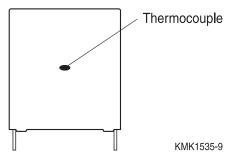


Figure 1

Box dimen	sions	Equivalent heat						
			coefficient					
w (mm)	h (mm)	I (mm)	G (mW/°C)					
11.0	19.0	31.5	25					
11.0	21.0	31.5	28					
12.5	21.5	31.5	30					
13.5	23.0	31.5	32					
14.0	24.5	31.5	35					
15.0	24.5	31.5	36					
16.0	32.0	31.5	45					
18.0	27.5	31.5	44					
18.0	33.0	31.5	48					
19.0	30.0	31.5	48					
20.0	11.0	31.5	65					
21.0	31.0	31.5	51					
22.0	36.5	31.5	58					
12.0	22.0	41.5	70					
14.0	25.0	41.5	43					
16.0	28.5	41.5	50					
18.0	32.5	41.5	59					
20.0	39.5	41.5	72					
24.0	19.0	41.5	50					
24.0	15.0	41.5	44					
28.0	37.0	42.0	83					
28.0	42.5	41.5	90					
30.0	45.0	42.0	100					
33.0	48.0	42.0	100					
43.0	22.0	41.5	80					
30.0	45.0	57.5	125					
35.0	50.0	57.5	145					
43.0	24.0	57.5	103					
45.0	57.0	57.5	185					
60.0	45.0	57.5	192					
130.0	24.0	57.5	200					
130.0	58.0	57.5	300					

The equivalent heat coefficient "**G** (**mW**/**°C**)" is given for measuring the temperature on the lateral surface of the plastic box as figure 1 shows. By using a thermocouple and avoiding effect of radiation and convection the temperature measured during operation conditions should be a result of the dissipated power divided by the equivalent heat coefficient.





Self Heating by power dissipation & equivalent heat coefficient

The I_{RMS} and consequently the power dissipation must be limited during operation in order to not exceed the maximum limit of ΔT allowed for this series. ΔT_{max} given for this series is equal or lower than 20 °C at rated temperature (70 °C), for higher ambient temperatures ΔT_{max} (T) will have the same derating factor than I_{RMS} versus temperature and then an equivalent derating as per: ambient temperatures ΔT_{max} (T) will have the same derating factor than I_{RMS} versus temperature and then an equivalent derating as per:

$$\Delta T_{\text{max}}$$
 (T) = (Factor)² × ΔT (70 °C).

For any particular I_{RMS} the ΔT may be calculated by:

$$\Delta T$$
 (°C) = P_{dis} (mW) / G(mW/°C).

Where ΔT (°C) is the difference between the temperature measured on the box (see figure 1) and the ambient temperature when capacitor is working during normal operation;

$$\Delta T$$
 (°C) = T_{op} (°C) $- T_{A}$ (°C).

It represents the increasing of temperature provoked by the I_{RMS} during operation. G (mW/°C) is the equivalent heat coefficient described above and P_{dis} (mW) is the dissipated power defined by:

$$P_{dis}$$
 (mW) = ESR_{typ} (m Ω) × I_{rms}^2 (A_{RMS}).

Example for thermal calculation:

We will take as reference B32778G0306K (30 $\mu F/1100 \ V$) type for thermal calculation.

Considering the following load and capacitor characteristics:

 I_{RMS} : 12 A_{RMS} at 20 kHz

T_A: 85 °C

 $30 \times 45 \times 57.5$ box

G (mW/°C): 125

Then we have to find the ESR_{typ} at 20 kHz what is approx . 8.2 m Ω .

So according to:

$$P_{dis}$$
 (mW) = ESR_{typ} (m Ω) × I_{rms}^2 (A_{RMS})

we have the following:

$$P_{dis}$$
 (mW) = 8.2 m $\Omega \times 12 A_{RMS}^2 = 1181 \text{ mW}$

and as per:

$$\Delta T$$
 (°C) = P_{dis} (mW) / G (mW/°C)

we have the following:

$$\Delta T$$
 (°C) = 1181 (mW) / 125 (mW/°C) = 9.5 °C.

What is below of the

$$\Delta T_{\text{max}}$$
 (85 °C) = (Factor)² × ΔT (70 °C) = (0.7)² × 20 °C = 9.8 °C.

On the other hand we may confirm that max I_{RMS} at 20 kHz at 70 °C = 17.5 A_{RMS}

And then max I_{RMS} for 85 °C of ambient temperature is defined as follows:

$$I_{RMS}$$
 (85 °C) = Factor × I_{RMS} (70 °C) = 0.7 × 17.5 A_{RMS} = 12.25 A_{RMS} .

What confirms once again that I_{RMS} (12 A_{RMS} at 20 kHz) is below the max specified for such frequency and ambient temperature.

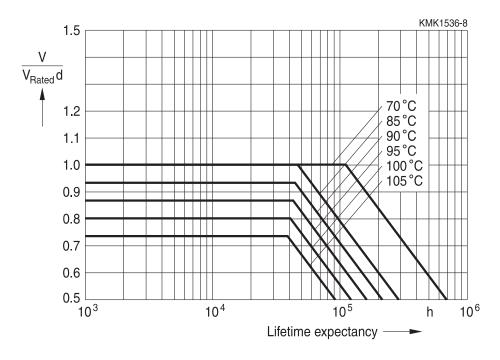




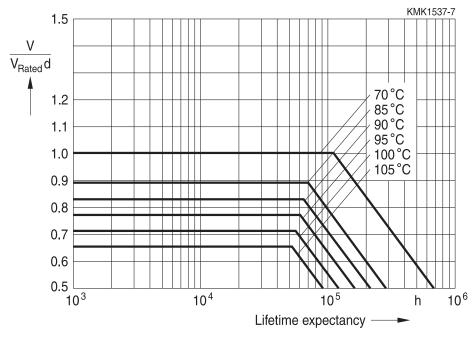
MKP DC link – high density series up to 480 μF

Life time expectancy - typical curves

B3277x-4 (450 V DC)



B3277x-5/8/9/0/1 (575 V DC / 800 V DC / 900 V DC / 1100 V DC / 1300 V DC)



Note: Confidence level of 95%





MKP DC link - high density series up to 480 μF

Testing and Standards

Test	Reference	Conditions of test		Performance requirements
Electrical parameters (Routine test)	IEC61071:2007	Voltage between terminals, 1.5 V_R , during 10 s Insulation resistance, R_{ins} at V_R if $V_R < 500$ V or 500 V if $V_R \ge 500$ V Capacitance, C at 1 kHz (room temperature) Dissipation factor, tan δ at 1/10 kHz (room temperature)		Within specified limits
Robustness of termina- tions (Type test)	IEC 60068-2-21-2006	Tensile strength (tensile strength) (tensile stren	Tensile force	Capacitance and δ within specified limits
Resistance to soldering heat (Type test)	IEC 60068-2-20:2008, test Tb, method 1A	Solder bath temperature at 260 ±5 °C, immersion for 10 seconds		$\Delta C/C_0 \le 2\%$ $ \Delta \tan \delta \le 0.002$
Rapid change of temperature (Type test)	IEC 60384-16:2005	T_A = lower category temperature T_B = upper category temperature Five cycles, duration t = 30 min.		$\begin{split} \Delta C/C_0 &\leq 2\% \\ \Delta \ tan \ \delta &\leq 0.002 \\ R_{ins} &\geq 50\% \ of \ initial \ limit \end{split}$
Vibration (Type test)	IEC 60384-16:2005	Test F _c : vibration sinusoidal Displacement: 0.75 mm Accleration: 98 m/s ² Frequency: 10 Hz 500 Hz Test duration: 3 orthogonal axes, 2 hours each axe		No visible damage
Bump (Type test)	IEC 60384-16:2005	Test Eb: Total 4000 bumps with 390 m/s² mounted on PCB 6 ms duration		No visible damage $ \Delta C/C_0 \leq 2\%$ $ \Delta \tan \delta \leq 0.002$ $R_{ins} \geq 50\% \text{ of initial limit}$
Climatic sequence (Type test)	IEC 60384-16:2005	Dry heat Tb / 16 h Damp heat cyclic, 1st cycle +55 °C / 24 h / 95% 100% RH Cold Ta / 2 h Damp heat cyclic, 5 cycles +55 °C / 24 h / 95% 100% RH		No visible damage $ \Delta C/C_0 \leq 3\%$ $ \Delta\ tan\ \delta \leq 0.001$ $R_{ins} \geq 50\% \ of \ initial \ limit$





MKP DC link – high density series up to 480 μF

Test	Reference	Conditions of test	Performance
			requirements
Damp heat,	IEC 60384-16:2005	Test Ca	No visible damage
steady state		40 °C / 93% RH / 56 days	$ \Delta C/C_0 \leq 5\%$
(Type test)			$ \Delta \tan \delta \le 0.005$
			$R_{ins} \ge 50\%$ of initial limit
Endurance	IEC 60384-16:2005	70 °C / 1.25 V _R / 1000 hours or	No visible damage
(Type test)		85 °C / 1.25 V _{op} / 1000 hours or	$ \Delta C/C_0 \le 5\%$ at 1 kHz
		100 °C / 1.25 V _{op} / 1000 hours	$ \Delta \tan \delta \le 0.005$
		·	$R_{ins} \ge 50\%$ of initial limit

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder



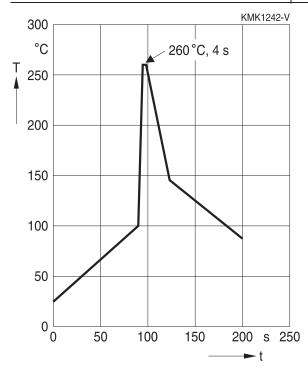


MKP DC link - high density series up to 480 μF

1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1. Conditions:

Series		Solder bath temperature	Soldering time
MKT	boxed (except 2.5 \times 6.5 \times 7.2 mm) coated	260 ±5 °C	10 ±1 s
	uncoated (lead spacing >10 mm)		
MFP			
MKP	(lead spacing >7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s
MKP	(lead spacing ≤7.5 mm)		<4 s
MKT	uncoated (lead spacing ≤10 mm)		recommended soldering
	insulated (B32559)		profile for MKT uncoated
			(lead spacing ≤ 10 mm) and
			insulated (B32559)



Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane	
Shield	Heat-absorbing board, (1.5 ± 0.5) mm thick, between	
	capacitor body and liquid solder	
Evaluation criteria:		
Visual inspection	No visible damage	
$\Delta C/C_0$	2% for MKT/MKP/MFP	
$\Delta C/C_0$	5% for EMI suppression capacitors	
$tan \ \delta$	As specified in sectional specification	





MKP DC link – high density series up to 480 μ F

1.3 General notes on soldering

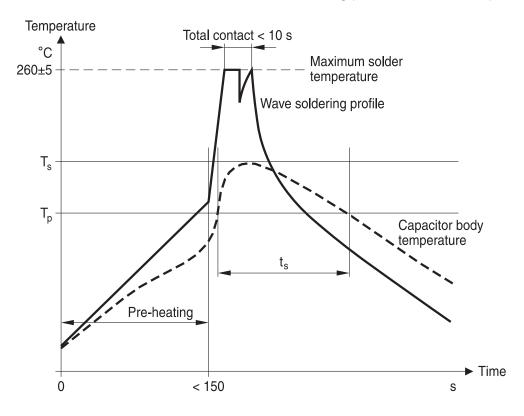
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:

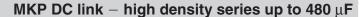


T_s: Capacitor body maximum temperature at wave soldering

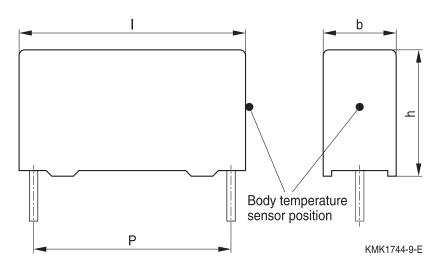
T_p: Capacitor body maximum temperature at pre-heating

KMK1745-A-E









Body temperature should follow the description below:

■ MKP capacitor

During pre-heating: $T_p \le 110 \, ^{\circ}\text{C}$ During soldering: $T_s \le 120 \, ^{\circ}\text{C}$, $t_s \le 45 \, \text{s}$

MKT capacitor

During pre-heating: $T_p \le 125 \,^{\circ}C$ During soldering: $T_s \le 160 \,^{\circ}C$, $t_s \le 45 \,^{\circ}S$

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be ≤ 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to EPCOS Film Capacitor Data Book in case more details are needed.





MKP DC link – high density series up to 480 μ F

Cautions and warnings

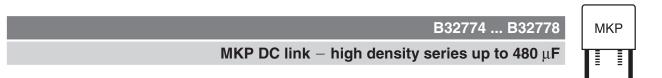
- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of EPCOS.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage	Make sure that capacitors are stored within the specified	
conditions	range of time, temperature and humidity conditions.	"Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive	5.3
	flammability), avoid overload of the capacitors (active	"Flammability"
	flammability) and consider the flammability of materials.	
Resistance to	Do not exceed the tested ability to withstand vibration.	5.2
vibration	The capacitors are tested to IEC 60068-2-6:2007.	"Resistance to
	EPCOS offers film capacitors specially designed for	vibration"
	operation under more severe vibration regimes such as	
	those found in automotive applications. Consult our	
	catalog "Film Capacitors for Automotive Electronics".	

Topic	Safety information	Reference chapter
		"Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits	1 "Soldering"
	during soldering.	
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"





Topic	Safety information	Reference chapter "Mounting guidelines"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.epcos.com/orderingcodes.





MKP DC link - high density series up to 480 μF

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_{C}	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
β_{C}	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
ΔC/C	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	Kapazitätstoleranz (relative Abweichung
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔΤ	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F_D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
Ic	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)





MKP DC link - high density series up to 480 μF

Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i _z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_{0}	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R_i	Internal resistance	Innenwiderstand
R _{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_s	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
tan $\delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan $\delta_{\scriptscriptstyle P}$	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan $\delta_{ extsf{S}}$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T _A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T_{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{ol}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T_{op}	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T _R	Rated temperature	Nenntemperatur
T _{ref}	Reference temperature	Referenztemperatur
t _{SL}	Reference service life	Referenz-Lebensdauer





MKP DC link - high density series up to 480 μF

Symbol	English	German
V_{AC}	AC voltage	Wechselspannung
V_{C}	Category voltage	Kategoriespannung
$V_{\text{C,RMS}}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_{i}	Input voltage	Eingangsspannung
V_{o}	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
ν̂ _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms of Delivery for Products and Services in the Electrical Industry" published by the German Electrical and Electronics Industry Association (ZVEI).



Important notes

- 7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
- 8. The trade names EPCOS, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.epcos.com/trademarks.

Release 2018-06

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for tdk manufacturer:

Other Similar products are found below:

VLF5012ST-1R0N2R5 C3225X5R0J686M200AC VLF5014AT-150MR76 VLF5014AT-6R8MR99 CXA-2115 MCZ1210AH301L2T
78P7200-IH/F MLP2012S1R5TT ACH3218-682-TD01 ACT45B-KIT NL565050T-822J-PF C1005JB1H471K050BA
C1608CH1H151J080AA C2012JB1H105K125AB C4532NP01H154J250KA SLF12575T-680M2R0-PF CD75-B2GA331KYGKA
CLF10040T-221M CLF12555T-220M MLF1005LR12K MLP2520S1R0ST MLP2520S1R5MT VLS252015T-3R3M1R0 VLS4012T150MR65 ZCAT-KIT MPZ2012-KIT NLV32T-R27J-EFD CKCM25C0G2A101K060AK CLF10040T-4R7N WTM505090-10K2-5V-G1
VLS252010HBX-R24M-1 CGJ2B2X7R1C222K CGA8M3X7R1H475K CGA9M1X7T2J334K CGA8P3X7T2E105M/S0FT
CGA6J4C0G2J392J CGA6M3X7R2E154K CGA3E3C0G2E181J CGA2B2C0G1H331J CEU-AC01-E6-KIT CERB3UX5R0G105M
RLF12545T-100M5R1-PF CCT406393-600-36-02 PFC3819QM-181K09B-00 VLF3010AT-100MR49 MMZ0603D330C
MPZ2012S102ATD25 MLG1608B18NJ UHV-251A FHV-11AN